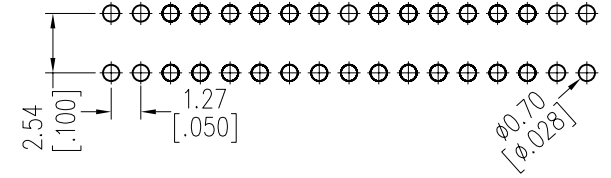
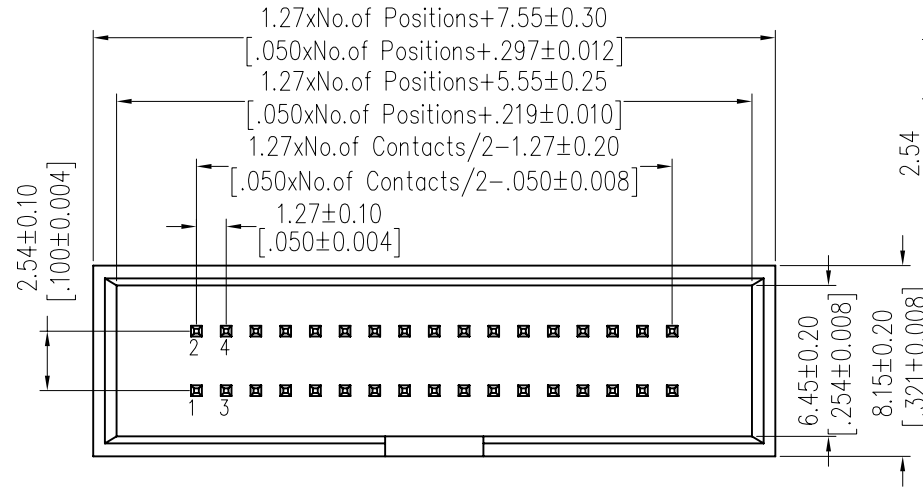


HSF

NOTES:
 Current Rating: 1.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 500V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Brass
 Contact plating: Au Or Sn over Ni
 Insulator Material: PA9T+30%G.F UL94V-0

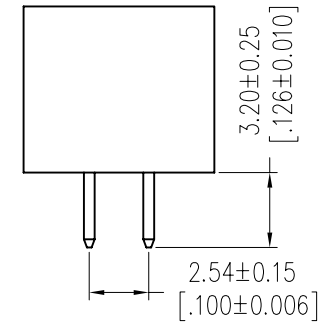
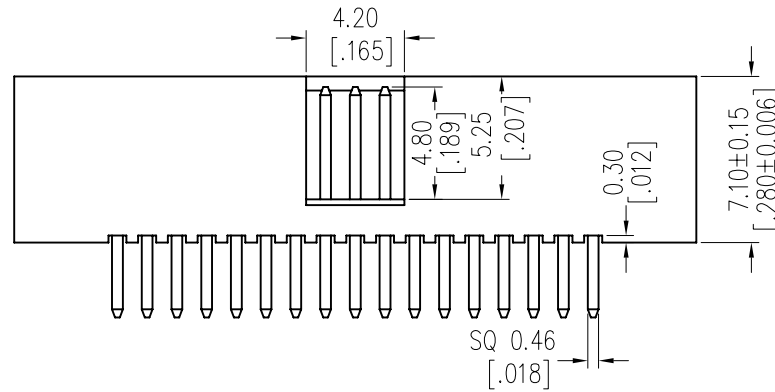
Recommended P.C.B Layout (Top Side)
 (PCB BOARD TOLERANCE ±0.05)



Ordering Information

3143-XX S XX B K00 X 1

No. of Pins	Contact Plating	Color	Packing
10	G0=Gold Flash	B=Black	T=Tube
14	G3=10u"Gold	W=White	
16	G4=15u"Gold		
20	G5=30u"Gold		
24	S0=Gold Flash/Tin		
26	S3=10u"Gold/Tin		
30	S4=15u"Gold/Tin		
80	S5=30u"Gold/Tin		
100	SN=Tin		



Item	Pitch	Mating
Standard	1.27X2.54	5242
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
				x.x ±0.40	JYHuang	2012/09/18	UNIT	mm	3143-XXSXXBK00X1
				x.xx ±0.25	CHECK	DATE	SIZE	A4	
				x.xxx ±0.15	APPROVE	DATE	SHEET	1/1	
				Angle ± 3'			PROJ.		Customer NO.
				DIM TOL					

TITLE:
1.27*2.54 BOX HEADER 180° H=7.10